PCN Number: 20180828001			PCN Date:			August 29, 2018			
Title: Datasheet for LM71, LM71-Q1									
Customer Contact:	CN Manage				Dept:		Quality Services		
Change Type:									
Assembly Site		Des	sign				Wafer	Bump Site	
Assembly Process		□ Dat	a Shee	t			Wafer	Bump Material	
Assembly Materials		Par	t numb	er change			Wafer	Bump Process	
Mechanical Specification		=	t Site					Fab Site	
Packing/Shipping/Labeling		Tes	Test Process					Fab Materials	
			otification Details				Wafer	Fab Process	
Notification Details Possiption of Change									
Description of Change: Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below.									
The following change history provides further details.									
The following change history provides further details.									
TEXAS									
INSTRUMENTS								LM71, LM71-Q1	
SNIS125E –MARCH 2004–REVISED AUGUST 2018									
Changes from Revision D (March 2013) to Revision E Page									
Added SNLA296 ulink to the temperature conversion time tablenote									
The datasheet number will be changing.									
Device Family			Change From:			Change To:			
LM71, LM71-Q1			SNIS125D			SNIS125E			
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/LM71									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to									
the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
LM71CIMF	LM71CIMF	-/NOPE	OPB LM71CIMF		/NOPB			LM71CISD/NOPB	
LM71QCIMF/NOPB	LM71QCIN				-			· · · · · · · · · · · · · · · · · · ·	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com